

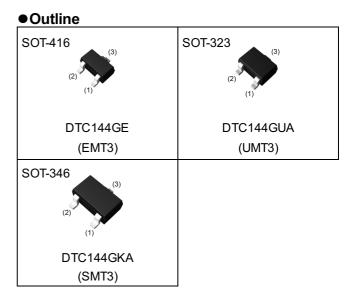
DTC144G series

NPN 100mA 50V Digital Transistors (Bias Resistor Built-in Transistors)

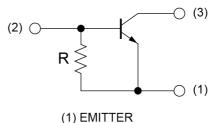
Parameter	Value
V _{CEO}	50V
۱ _C	100mA
R	47kΩ

Features

- 1)Built-In Biasing Resistor
- 2)The bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input. They also have the advantage of completely eliminating parasitic effects.
- 3)Complementary PNP Types: DTA144G series



●Inner circuit



(1) EMITTER(2) BASE(3) COLLECTOR

Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC144GE	SOT-416 (EMT3)	1616	TL	180	8	3000	K26
DTC144GUA	SOT-323 (UMT3)	2021	T106	180	8	3000	K26
DTC144GKA	SOT-346 (SMT3)	2928	T146	180	8	3000	K26

DTC144G series

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

F	Parameter			Unit
Collector-base voltage			50	V
Collector-emitter voltage			50	V
Emitter-base voltage			5	V
Collector current		Ι _C	100	mA
	DTC144GE		150	
Power dissipation	DTC144GUA	P _D ^{*1}	200	mW
DTC144GKA			200	
Junction temperature		Tj	150	°C
Range of storage temperature			-55 to +150	°C

• Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Cumb al	Conditions	Values			Unit	
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV _{CBO}	Ι _C = 50μΑ	50	-	-	V	
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	50	-	-	V	
Emitter-base breakdown voltage	BV_{EBO}	Ι _Ε = 160μΑ	5	-	-	V	
Collector cut-off current	I _{CBO}	V _{CB} = 50V	-	-	500	nA	
Emitter cut-off current	I _{EBO}	V _{EB} = 4V	65	-	130	μA	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 10mA, I _B = 0.5mA	-	-	300	mV	
DC current gain	h _{FE}	V _{CE} = 5V, I _C =5mA	68	-	-	-	
Emitter-base resistance	R	-	32.9	47	61.1	kΩ	
Transition frequency	f _T *2	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz	

*1 Each terminal mounted on a reference land.

*2 Characteristics of built-in transistor.



• Electrical characteristic curves ($T_a = 25^{\circ}C$)

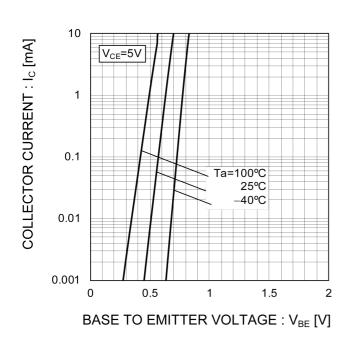


Fig.1 Grounded emitter propagation characteristics

Fig.2 Grounded emitter output characteristics

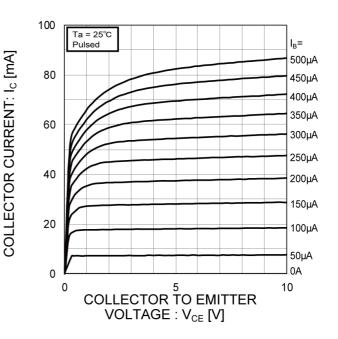
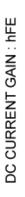
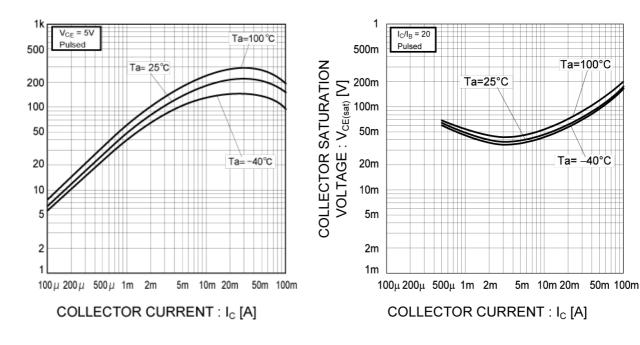


Fig.3 DC Current gain vs. Collector Current

Fig.4 Collector-emitter saturation voltage vs. Collector Current



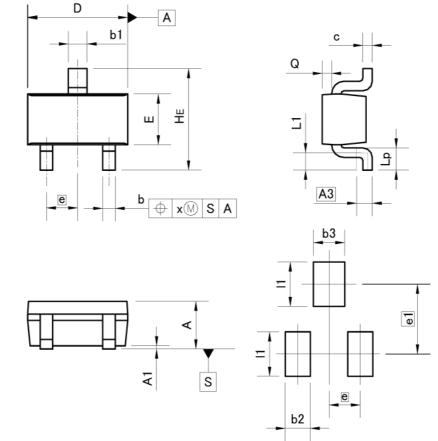




Dimensions



(EMT3)



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
А	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
Е	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	-	0.004	-
Lp	0.15	-	0.006	-
Q	0.05	0.25	0.002	0.010
x		0.10	-	0.004

DIM		MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.40	-	0.016
b3	-	0.50	-	0.020
e1	1.10		0.0	43
1	1. 	0.70	-	0.028

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0	0.004
A3	0.2	25	0.0	01
b	0.25	0.40	0.01	0.016
с	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.0	03
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.02
Lp	0.25	0.55	0.01	0.022
Q	0.10	0.30	0.004	0.012
x	_	0.10	-	0.004

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
e1	1.55		0.06		
b2	-	0.50	Ι	0.02	
1	-	0.65	-	0.026	

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
А	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.	95	0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
х	—	0.10	-	0.004
У	-	0.10	-	0.004
DIM	MILIM	ETERS	INC	HES

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.60	-	0.024
e1	2.10		0.0	83
1	-	0.90	-	0.035

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

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	JAPAN	USA	EU	CHINA
	CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
	CLASSⅣ	CLASSI	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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QR code printed on ROHM Products label is for ROHM's internal use only.

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